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October 1995 Revised August 2004

NC7S86

TinyLogic® HS 2-Input Exclusive-OR Gate

General Description

The NC7S86 is a single 2-Input high performance CMOS Exclusive-OR Gate. Advanced Silicon Gate CMOS fabrication assures high speed and low power circuit operation over a broad V_{CC} range. ESD protection diodes inherently guard both inputs and output with respect to the V_{CC} and GND rails. Inputs are well buffered from the output to assure high noise immunity and reduced sensitivity to input edge rate.

Features

- Space saving SOT23 or SC70 5-lead package
- Ultra small MicroPak™ leadless package
- High Speed; t_{PD} 4.5 ns typ
- Low Quiescent Power; I_{CC} < 1 µA
- Balanced Output Drive; 2 mA I_{OL}, -2 mA I_{OH}
- Broad V_{CC} Operating Range; 2V–6V
- Balanced Propagation Delays

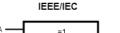
Connection Diagrams

■ Specified for 3V operation

Ordering Code:

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
NC7S86M5X	MA05B	7S86	5-Lead SOT23, JEDEC MO-178, 1.6mm	3k Units on Tape and Reel
NC7S86P5X	MAA05A	S86	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3k Units on Tape and Reel
NC7S86L6X	MAC06A	ZZ	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

Logic Symbol



Pin Descriptions

Pin Names	Description
A, B	Input
Y	Output
NC	No Connect

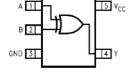
Function Table

$$Y = A \oplus B$$

	Inp	Output	
ĺ	Α	В	Y
ĺ	L	L	L
	L	Н	Н
	Н	L	Н
	Н	Н	L
		Н	L H H L

H = HIGH Logic Level

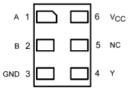
L = LOW Logic Level



Pin Assignments for SC70 and SOT23

(Top View)

Pad Assignment for MicroPak



(Top Thru View)

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Absolute Maximum Ratings(Note 1)

Recommended Operating Conditions (Note 2)

Supply Voltage (V _{CC})	-0.5V to +7.0V	Cor
DC Input Diode Current (I _{IK})		Supp
@ $V_{IN} \le -0.5V$	-20 mA	Input
@ $V_{IN} \ge V_{CC} + 0.5V$	+20 mA	Outp
DC Input Voltage (V _{IN})	$-0.5V$ to $V_{CC} + 0.5V$	Oper
DC Output Diode Current (I _{OK})		Input
@ V _{OUT} < -0.5V	-20 mA	Vc
@ $V_{OUT} > V_{CC} + 0.5V$	+20 mA	Vc
DC Output Voltage (V _{OUT})	$-0.5V$ to $V_{CC} + 0.5V$	Vc
DC Output Source		Vc

or Sink Current (I_{OUT}) $\pm 12.5 \text{ mA}$

 $\begin{array}{lll} \text{DC V}_{\text{CC}} \text{ or Ground Current} \\ \text{per Output Pin (I}_{\text{CC}} \text{ or I}_{\text{GND}}) & \pm 25 \text{ mA} \\ \text{Storage Temperature (T}_{\text{STG}}) & -65^{\circ}\text{C to +150}^{\circ}\text{C} \end{array}$

Junction Temperature (T_J) 150°C Lead Temperature (T_L); (Soldering, 10 seconds) 260°C

Power Dissipation (P_D) @ +85°C

SOT23-5 200 mW SC70-5 150 mW

ply Voltage (V_{CC}) 2.0V to 6.0V ıt Voltage (V_{IN}) 0V to V_{CC} 0V to V_{CC} put Voltage (V_{OUT}) erating Temperature (T_A) -40°C to +85°C ut Rise and Fall Time (t_f, t_f) CC @ 2.0V 0 to 1000 ns cc @ 3.0V 0 to 750 ns cc @ 4.5V 0 to 500 ns CC @ 6.0V 0 to 400 ns Thermal Resistance (θ_{JA}) SOT23-5 300°C/W

SC70-5 425°C/W
te 1: Absolute maximum ratings are those values beyond which damage

Note 1: Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation of circuits outside databook specifications.

Note 2: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

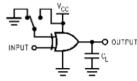
Symbol Parameter (V) Min Typ	B.4		$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$		Conditions
	Max	Min	Max	Units	Conditions
V _{IH} HIGH Level Input Voltage 2.0 1.50		1.50		v	
3.0-6.0 0.7 V _{CC}		0.7 V _{CC}		*	
V _{IL} LOW Level Input Voltage 2.0	0.50		0.50	v	
3.0-6.0	$0.3V_{\rm CC}$		$0.3V_{CC}$	°	
V _{OH} HIGH Level Output Voltage 2.0 1.90 2.0		1.90			
3.0 2.90 3.0		2.90		l v	$I_{OH} = -20 \mu A$ $V_{IN} = V_{IH}, V_{IL}$
4.5 4.40 4.5		4.40		°	$V_{IN} = V_{IH}, V_{IL}$
6.0 5.90 6.0		5.90			
					$V_{IN} = V_{IH}, V_{IL}$
3.0 2.68 2.85		2.63		l v	$I_{OH} = -1.3 \text{ mA}$
4.5 4.18 4.35		4.13		°	$I_{OH} = -2 \text{ mA}$
6.0 5.68 5.85		5.63			$I_{OH} = -2.6 \text{ mA}$
V _{OL} LOW Level Output Voltage 2.0 0.0	0.10		0.10		
3.0 0.0	0.10		0.10	l v	$I_{OL} = 20 \mu A$
4.5 0.0	0.10		0.10	*	$V_{IN} = V_{IH}$ or V_{IL}
6.0 0.0	0.10		0.10		
					$V_{IN} = V_{IH}$ or V_{IL}
3.0 0.1	0.26		0.33	l v	$I_{OL} = 1.3 \text{ mA}$
4.5 0.1	0.26		0.33		$I_{OL} = 2 \text{ mA}$
6.0 0.1	0.26		0.33		I _{OL} = 2.6 mA
I _{IN} Input Leakage Current 6.0	±0.1		±1.0	μА	$V_{IN} = V_{CC}$, GND
I _{CC} Quiescent Supply Current 6.0	1.0		10.0	μΑ	$V_{IN} = V_{CC}$, GND

AC Electrical Characteristics

Symbol	Parameter	V _{cc}		$T_A = +25^{\circ}C$		$T_A = -40$ °C to $+85$ °C	Units	Conditions	Figure
oymbo.	- arameter	(V)	Min	Тур	Max	Min Max	7 01	Conditions	Number
t _{PLH} ,	Propagation Delay	5.0		4.5	17		ns	C _L = 15 pF	
t_{PHL}		2.0		22	100	125			1
		3.0		12	27	35			Figures 1, 3
		4.5		8.5	20	25	ns	C _L = 50 pF	
		6.0		7	17	21			
t _{TLH} ,	Output Transition Time	5.0		3	8		ns	C _L = 15 pF	
t _{THL}		2.0		25	125	155			1
		3.0		16	35	45		C 50 -F	Figures 1. 3
		4.5		11	25	31	ns	C _L = 50 pF	1, 5
		6.0		9	21	26			
C _{IN}	Input Capacitance	Open		2	10	10	pF		
C _{PD}	Power Dissipation Capacitance	5.0		8			pF	(Note 3)	Figure 2

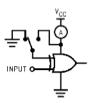
Note 3: C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 2.) C_{PD} is related to I_{CCD} dynamic operating current by the expression: $I_{CCD} = (C_{PD})(V_{CC})(f_{\parallel N}) + (I_{CC}static)$.

AC Loading and Waveforms



 $\mathbf{C}_{\mathbf{L}}$ includes load and stray capacitance

Input PRR = 1.0 MHz; $t_{\rm W}\!=\!500~{\rm ns}$ $\mbox{FIGURE 1. AC Test Circuit}$



Input = AC Waveform;

 $\text{PRR} = \text{variable}; \ \text{Duty Cycle} = 50\%$

FIGURE 2. I_{CCD} Test Circuit

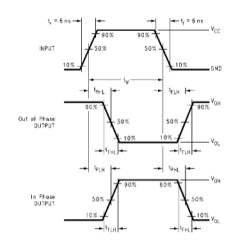


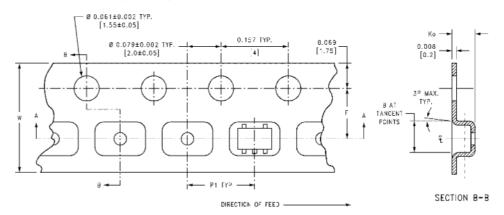
FIGURE 3. AC Waveforms

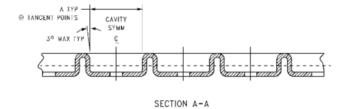
Tape and Reel Specification

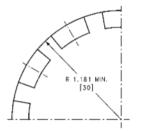
TAPE FORMAT for SC70 and SOT23

Package	Tape	Number	Cavity	Cover Tape	
Designator	Section	Cavities	Status	Status	
	Leader (Start End)	125 (typ)	Empty	Sealed	
M5X, P5X	Carrier	3000	Filled	Sealed	
	Trailer (Hub End)	75 (typ)	Empty	Sealed	

TAPE DIMENSIONS inches (millimeters)







BEND RADIUS NOT TO SCALE

Package	Tape Size	DIM A	DIM B	DIM F	DIM K _o	DIM P1	DIM W
SC70-5	8 mm	0.093	0.096	0.138 ±0.004	0.053 ±0.004	0.157	0.315 ±0.004
		(2.35)	(2.45)	(3.5 ±0.10)	(1.35 ±0.10)	(4)	(8 ±0.1)
SOT23-5	8 mm	0.130	0.130	0.138 ±0.002	0.055 ±0.004	0.157	0.315 ±0.012
		(3.3)	(3.3)	(3.5 ±0.05)	(1.4 ±0.11)	(4)	(8 ±0.3)

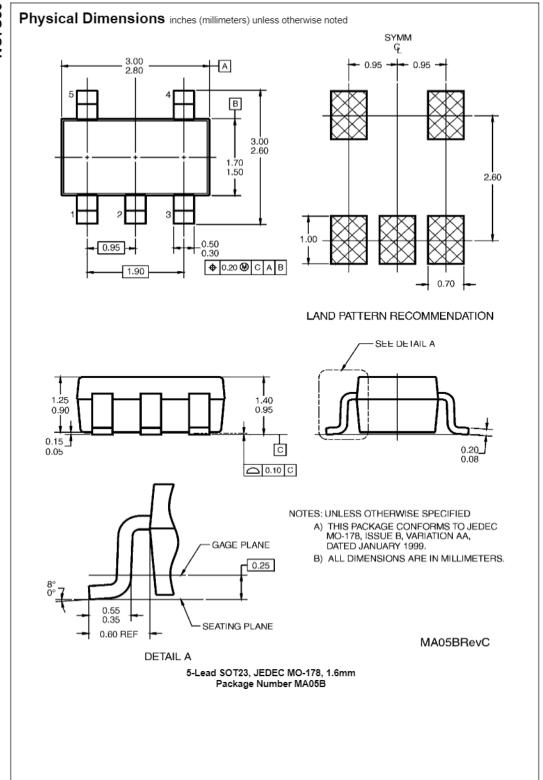
Tape and Reel Specification (Continued) TAPE FORMAT for MicroPak Package Tape Number Cavity Cover Tape Status Designator Section Cavities Status Leader (Start End) 125 (typ) Empty Sealed L6X Carrier 5000 Filled Sealed 75 (typ) Trailer (Hub End) Empty Sealed 4.00 1.75±0.10 В 8.00 +0.30 -0.10 3.50±0.05 -ø 0.50 ±0.05 SECTION B-B SCALE:10X DIRECTION OF FEED 0.254±0.020 Γ 0.70±0.05 SECTION A-A SCALE:10X REEL DIMENSIONS inches (millimeters) TAPE SLOT

Tape Size	Α	В	С	D	N	W1	W2	W3
8 mm	7.0 (177.8)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	2.165 (55.00)	0.331 +0.059/-0.000 (8.40 +1.50/-0.00)	0.567 (14.40)	W1 +0.078/-0.039 (W1 +2.00/-1.00)
	(117.0)	(1.00)	(10.00)	(20.20)	(00.00)	(6. 10 11.00/ 0.00)	(11.10)	(*** 12.00/ 1.00/

DETAIL X

DETAIL X

SCALE: 3X



Physical Dimensions inches (millimeters) unless otherwise noted (Continued) 2.00±0.20 0.65 1.25±0.10 2.10±0.10 0.4 min 0.20 +0.10 LAND PATTERN RECOMMENDATION ♦ max 0.1 ② SEE DETAIL A 0.9±.10 0.95±0.15 ____ max 0.1 R0.14 GAGE PLANE H0.10 0.20 - 0.425 NOMINAL DETAIL A

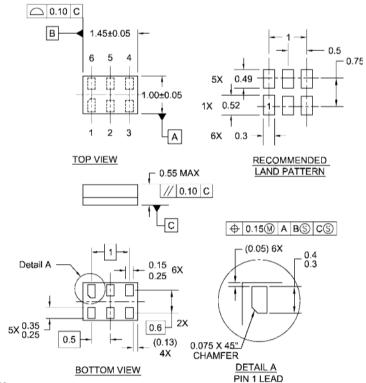
NOTES:

A. CONFORMS TO EIAJ REGISTERED OUTLINE DRAWING SC88A. B. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. C. DIMENSIÓNS ARE IN MILLIMETERS.

MAA05ARevC

5-Lead SC70, EIAJ SC-88a, 1.25mm Wide Package Number MAA05A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

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